

**N-channel 80 V, 0.0056 Ω typ., 110 A, STripFET™ F6
Power MOSFET in a TO-220 package**

Datasheet - production data

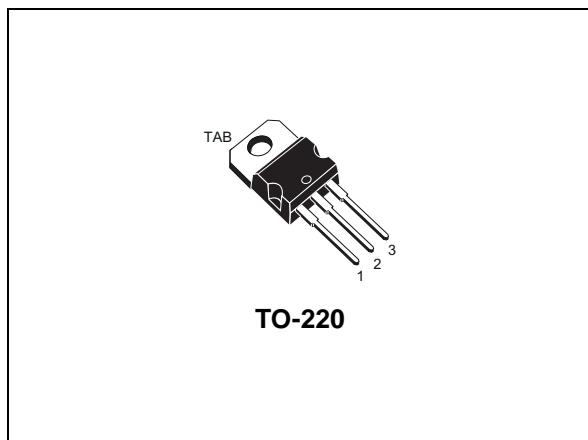
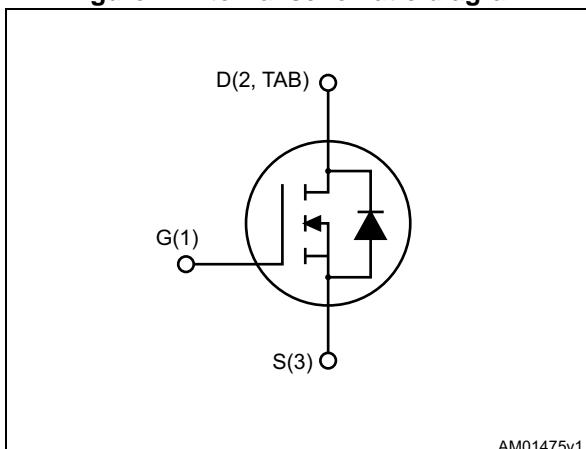


Figure 1. Internal schematic diagram



Features

| Order code | V _{DS} | R _{DS(on)max} | I _D | P _{TOT} |
|------------|-----------------|------------------------|----------------|------------------|
| STP110N8F6 | 80 V | 0.0065 Ω | 110 A | 200 W |

- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

Applications

- Switching applications

Description

This device is an N-channel Power MOSFET developed using the STripFET™ F6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low R_{DS(on)} in all packages.

Table 1. Device summary

| Order code | Marking | Package | Packing |
|------------|---------|---------|---------|
| STP110N8F6 | 110N8F6 | TO-220 | Tube |

1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|----------------|---|------------|------------------|
| V_{DS} | Drain-source voltage | 80 | V |
| V_{GS} | Gate-source voltage | ± 20 | V |
| I_D | Drain current (continuous) at $T_C = 25^\circ\text{C}$ | 110 | A |
| I_D | Drain current (continuous) at $T_C = 100^\circ\text{C}$ | 85 | A |
| $I_{DM}^{(1)}$ | Drain current (pulsed) | 440 | A |
| P_{TOT} | Total dissipation at $T_C = 25^\circ\text{C}$ | 200 | W |
| $E_{AS}^{(2)}$ | Single pulse avalanche energy | 180 | mJ |
| T_J | Operating junction temperature | -55 to 175 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature | | $^\circ\text{C}$ |

1. Pulse width is limited by safe operating area

2. Starting $T_J = 25^\circ\text{C}$, $I_D = 55\text{ A}$, $V_{DD} = 60\text{ V}$

Table 3. Thermal data

| Symbol | Parameter | Value | Unit |
|----------------|--|-------|--------------------|
| $R_{thj-case}$ | Thermal resistance junction-case max. | 0.75 | $^\circ\text{C/W}$ |
| $R_{thj-amb}$ | Thermal resistance junction-ambient max. | 62.5 | $^\circ\text{C/W}$ |

2 Electrical characteristics

($T_C = 25^\circ\text{C}$ unless otherwise specified)

Table 4. On/off-state

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------|------------------------------------|--|------|--------|--------|---------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage | $V_{GS} = 0$, $I_D = 1 \text{ mA}$ | 80 | | | V |
| I_{DSS} | Zero-gate voltage drain current | $V_{GS} = 0$, $V_{DS} = 80 \text{ V}$ | | | 1 | μA |
| | | $V_{GS} = 0$, $V_{DS} = 80 \text{ V}$, $T_C = 125^\circ\text{C}$ | | | 100 | μA |
| I_{GSS} | Gate-body leakage current | $V_{DS} = 0$, $V_{GS} = +20 \text{ V}$ | | | 100 | nA |
| $V_{GS(\text{th})}$ | Gate threshold voltage | $V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$ | 2.5 | | 4.5 | V |
| $R_{DS(\text{on})}$ | Static drain-source on- resistance | $V_{GS} = 10 \text{ V}$, $I_D = 55 \text{ A}$ | | 0.0056 | 0.0065 | Ω |

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|--|------|------|------|------|
| C_{iss} | Input capacitance | $V_{DS} = 40 \text{ V}$, $f = 1 \text{ MHz}$, $V_{GS} = 0$ | - | 9130 | - | pF |
| C_{oss} | Output capacitance | | - | 320 | - | pF |
| C_{rss} | Reverse transfer capacitance | | - | 225 | - | pF |
| Q_g | Total gate charge | $V_{DD} = 40 \text{ V}$, $I_D = 110 \text{ A}$, $V_{GS} = 10 \text{ V}$ | - | 150 | - | nC |
| Q_{gs} | Gate-source charge | | - | 40 | - | nC |
| Q_{gd} | Gate-drain charge | | - | 30 | - | nC |

Table 6. Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------------|---------------------|--|------|------|------|------|
| $t_{d(\text{on})}$ | Turn-on delay time | $V_{DD} = 40 \text{ V}$, $I_D = 55 \text{ A}$, $R_G = 4.7 \Omega$, $V_{GS} = 10 \text{ V}$ | - | 24 | - | ns |
| t_r | Rise time | | - | 61 | - | ns |
| $t_{d(\text{off})}$ | Turn-off delay time | | - | 162 | - | ns |
| t_f | Fall time | | - | 48 | - | ns |

Table 7. Source-drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|----------------|--------------------------|--|------|------|------|------|
| $V_{SD}^{(1)}$ | Forward on voltage | $I_{SD} = 110 \text{ A}$, $V_{GS} = 0$ | - | | 1.2 | V |
| t_{rr} | Reverse recovery time | $I_{SD} = 110 \text{ A}$, $di/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 64 \text{ V}$ (see) | - | 30 | | ns |
| Q_{rr} | Reverse recovery charge | | - | 34 | | nC |
| I_{RRM} | Reverse recovery current | | - | 2.3 | | A |

1. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

